Electronic Patent Application Fee Transmittal							
Application Number:	10695969						
Filing Date:	29-Oct-2003						
Title of Invention:	Sei	Semiconductor integrated circuit and semiconductor substrate of the same					
First Named Inventor/Applicant Name:	Hiroaki Ohkubo						
Filer:	Hassan Abbas Shakir/Christina Colocotronis						
Attorney Docket Number:	NECF 20.702						
Filed as Large Entity							
Utility under 35 USC 111(a) Filing Fees							
Description		Fee Code	Quantity	Amount	Sub-Total in USD(\$)		
Basic Filing:							
Pages:							
Claims:							
Miscellaneous-Filing:							
Petition:							
Patent-Appeals-and-Interference:							
Post-Allowance-and-Post-Issuance:							
Extension-of-Time:							

Description	Fee Code	Quantity	Amount	Sub-Total in USD(\$)
Miscellaneous:				
Request for continued examination	1801	1	810	810
	Tot	810		